

**NIRMA UNIVERSITY**  
**SCHOOL OF TECHNOLOGY, INSTITUTE OF TECHNOLOGY**  
**M.Tech. in Electronics & Communication Engineering (VLSI Design)**  
**M.Tech. Semester - II**  
**Department Elective III**

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<b>Course Code</b>	<b>6EC173ME22</b>
<b>Course Title</b>	<b>MEMS Design</b>

**Course Learning Outcomes (CLOs):**

At the end of the course, students will be able to -

1. Comprehend the concepts of advanced Micro/Nano fabrication technologies.
2. Develop the applications of MEMS in area of optical, modulators, switches, and displays.
3. Apply design techniques of RF MEMS switches, relays, varactor, phase shifter, antennas.

**Syllabus:**

**Teaching Hours:45**

**UNIT I: Introduction to MEMS** **08**

Advanced Micro/Nano Fabrication Technologies: Plasma physics, ICP etch, Deep Si etch, Deep oxide etch, Surface micromachining, Bulk micromachining: multiple wafer stack, SOI, SCREAM, CMOS-MEMS: Thin-film, bulk, DRIE, CMOS-based Sensors and Interface Circuits Design

**UNIT II: Electrical, Mechanical and Optical properties of MEMS material** **10**

Chemical, Thermal, Inertial, Interface circuit design, Optical MEMS: Fundamentals of light: Propagation, Interference, Doppler Effect, Polarization, Coherence, Micromirrors, Microlens; Microgratings Corner cube reflectors, Optical communications, case study

**UNIT III: Applications of MEMS** **10**

Phase modulators, attenuators, switches, Displays, Scanners, Biosensors, Spectroscopy

**UNIT IV: RF MEMS** **13**

RF MEMS switches and Micro Relays, MEMS varactors and inductors, MEMS phase shifters and filters, Micro machined Antenna, case study

**UNIT V: MEMS Packaging** **04**

Packaging design, materials, Packaging techniques: Bonding, Sealing, Dicing, Wafer-level packaging, Packaging for medical, aerospace and RF MEMS applications

**Self-Study:**

The self-study contents will be declared at the commencement of Semester. Around 10% of the questions will be asked from self-study contents.

**Laboratory Work:**

Laboratory work will be based on above syllabus with minimum 10 experiments to be incorporated.

**Suggested Readings:**

1. G. Kovacs, Micromachined Transducers Sourcebook, McGraw-Hill
2. S. Senturia, Microsystem Design, Kluwer Academic Publishers
3. M. Madou, Fundamentals of Microfabrication, Chemical Rubber Company Press
4. G. Rebeiz, RF MEMS: Theory, Design and Technology, John Wiley & Sons
5. B. Bouma and G. Tearney, Handbook of Optical Coherence Tomography, Marcel Dekker Inc